

# Jun Tian

## List of Publications by Year in descending order

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2682572  
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#	ARTICLE	IF	CITATIONS
1	Weighted Distribution Constraint Based Prediction of Available Interval of Coaxial-to-Microstrip Flexible Interconnection. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2022, 12, 316-328.	2.5	2
2	Equivalent Circuit-Based Coupling Modeling of Double Bond Ribbons Interconnection Variation in Electronic Packaging. IEEE Microwave and Wireless Components Letters, 2022, , 1-4.	3.2	0
3	Electromechanical Coupling Parameter Identification for Flexible Conductor Wire Interconnection Considering Interaction Effect in Microwave Circuits. Electronics (Switzerland), 2021, 10, 464.	3.1	4
4	A key parameters interval estimation method of the gold ribbon interconnect structure for the electrical performance of microwave modules. , 2020, , .		2